

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

- Dual-side cooled package with lowest Junction-top thermal resistance
- N-channel, normal level
- N-channer, normal level
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 175 °C operating temperature
 Pb-free lead plating; RoHS compliant

- Ideal for high-frequency switching and synchronous rectification

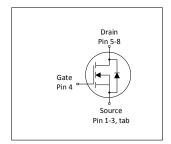
Product validation

Fully qualified according to JEDEC for Industrial Applications

Kev Performance Parameters Table 1

Parameter	Value	Unit
V _{DS}	150	V
R _{DS(on),max}	11	mΩ
I _D	77	A
Q _{rr}	46	nC











Type / Ordering Code	Package	Marking	Related Links
BSC110N15NS5SC	PG-WSON-8	110N15SC	-

OptiMOS[™] 5 Power-Transistor, 150 V BSC110N15NS5SC



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OptiMOS[™] 5 Power-Transistor, 150 V BSC110N15NS5SC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damanastan	Cymphol	Values			I I m i 4	Nata / Taat Oan ditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	77 55	А	T _C =25 °C T _C =100 °C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	308	Α	T _C =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	90	mJ	I_D =50 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	150	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			l lmit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.6	1.0	K/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.36	0.72	K/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁴⁾	R _{thJA}	-	-	50	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

²⁾ See Diagram 3 for more detailed information

³⁾ See Diagram 13 for more detailed information

⁴⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Danish at an	0		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	3	3.8	4.6	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =91 μ A
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	9 10	11 13	mΩ	V _{GS} =10 V, I _D =38 A V _{GS} =8 V, I _D =19 A
Gate resistance	R _G	-	0.9	1.35	Ω	-
Transconductance	g fs	29	58	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 38 A$

Table 5 Dynamic characteristics

Davamatav	Comple ed	Values			1114	Note (Total Constitution
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	2080	2770	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	515	685	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	13	23	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	10.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	3.3	-	ns	$V_{\rm DD} = 75 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 38 \text{ A}, \ R_{\rm G,ext} = 3 \ \Omega$
Turn-off delay time	$t_{ m d(off)}$	-	14.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	2.9	<u></u>	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Combal	Values			111414	Nata / Tant Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	12	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	5.8	8.7	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	11.5	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	28	35	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	5.8	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	78	103	nC	V _{DD} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

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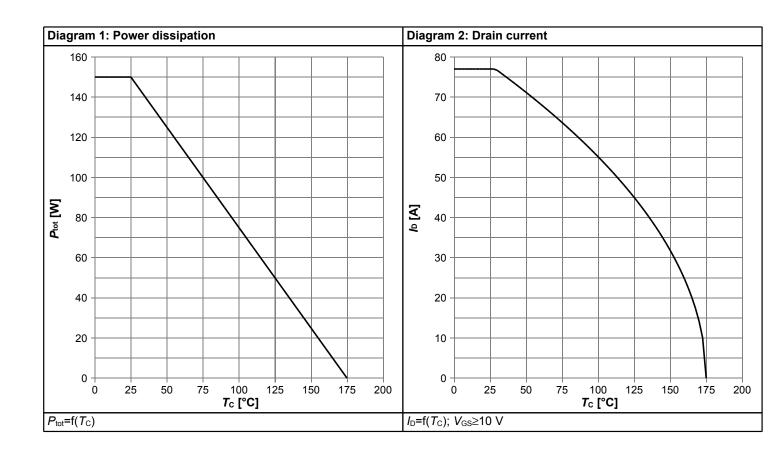


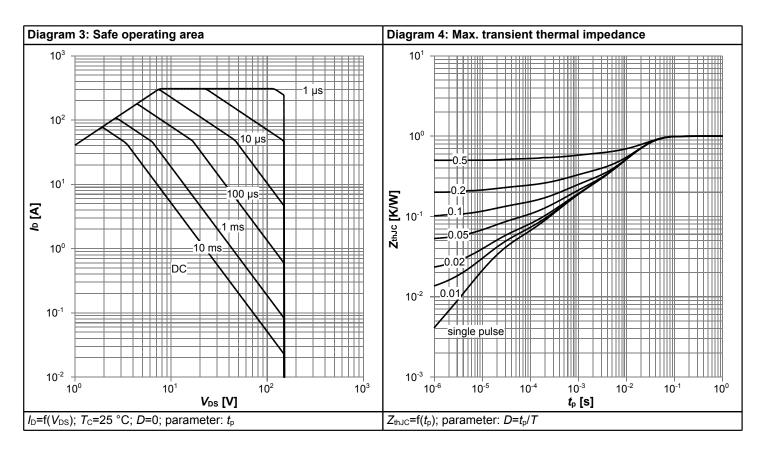
Table 7 Reverse diode

Parameter	Combal		Values			Nata (Tant Oan dition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	77	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	308	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, I _F =38 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	45	90	ns	V _R =75 V, I _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	46	92	nC	V _R =75 V, I _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

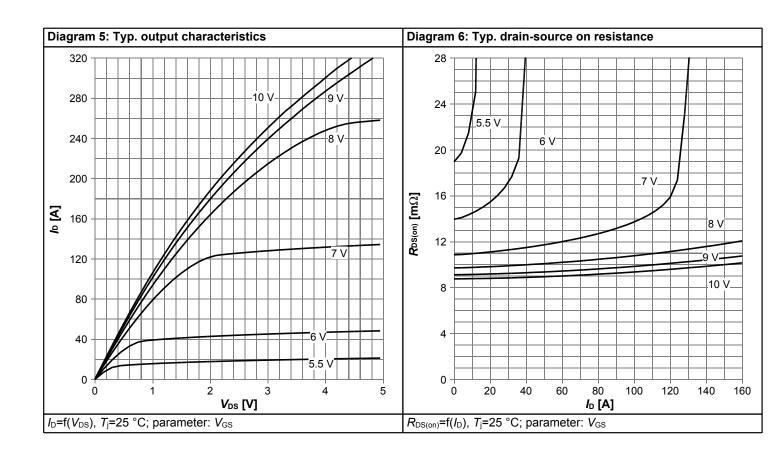


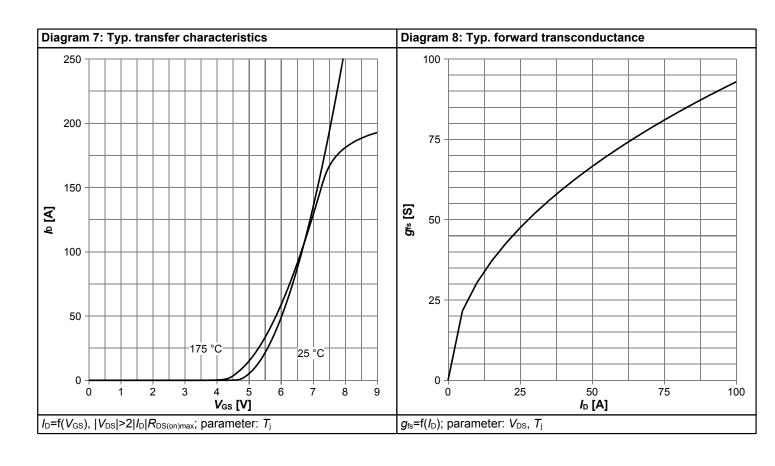
4 Electrical characteristics diagrams



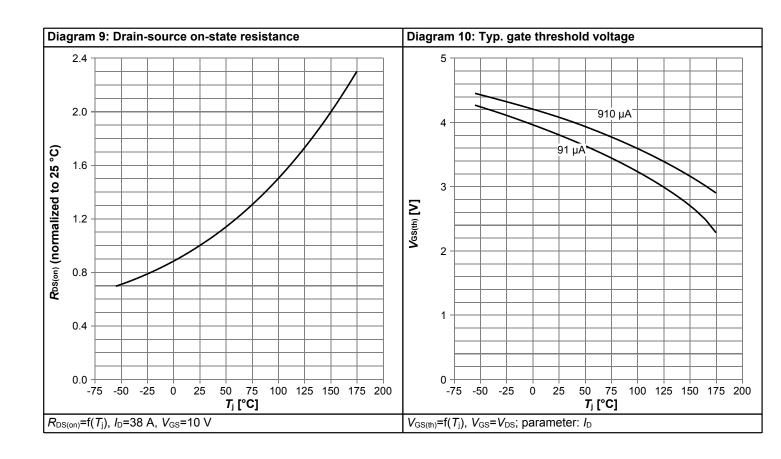


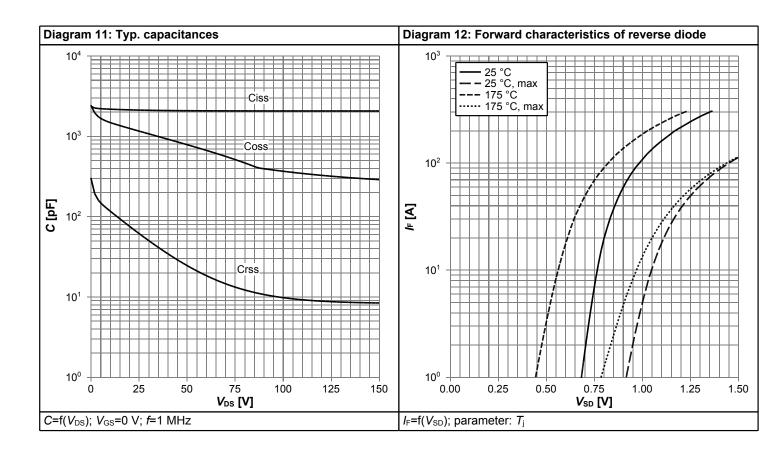




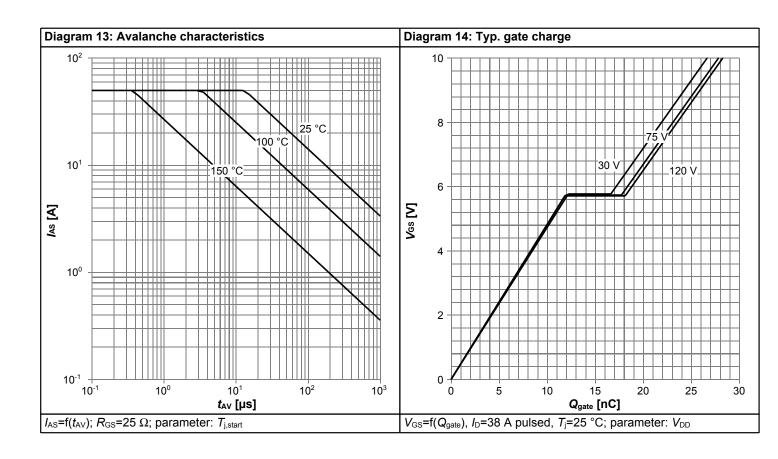


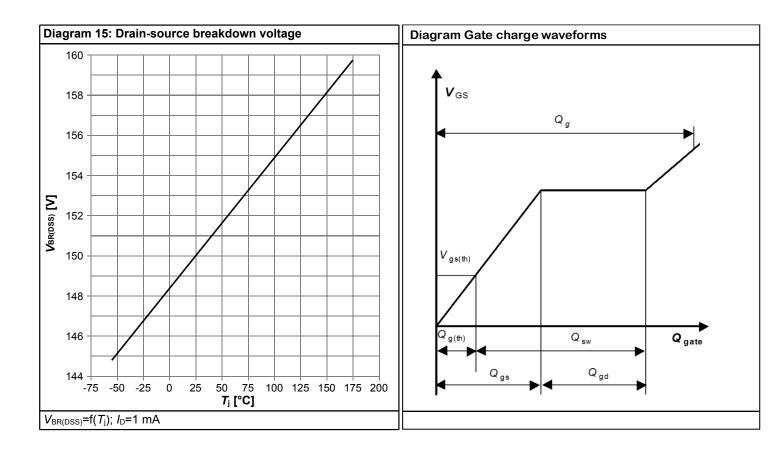






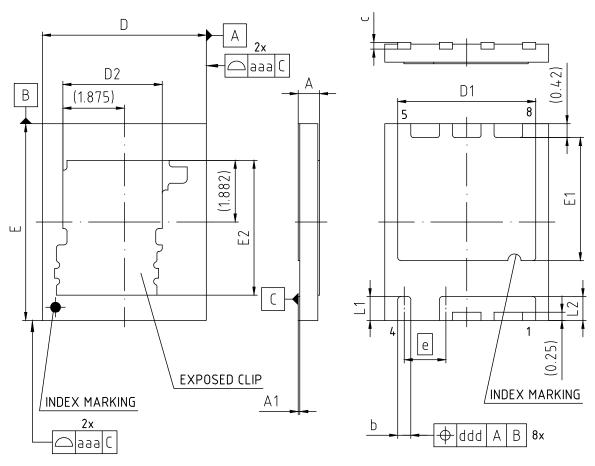








5 Package Outlines



DIMENSIONS DOES NOT INCLUDE MOLD FLASH OR MOLD PROTRUSIONS.

DIMENSION	MILLI	METERS			
DIMENSION	MIN.	MAX.			
Α	-	0.75			
A1	-	0.05			
b	0.35	0.45			
С	0	.203			
D	4.95 5.05				
D1	4.11 4.31				
D2	3.03				
E	5.95 6.05				
E1	3.66 3.86				
E2	4.11				
е	1.27				
L1	0.675 0.775				
L2	0.625 0.825				
aaa	(0.05			
ddd	().10			

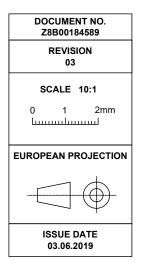


Figure 1 Outline PG-WSON-8, dimensions in mm

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Revision History

BSC110N15NS5SC

Revision: 2022-10-07, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2022-09-17	Release of final version				
2.1	2022-10-07	Update "Features"				

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